

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Earlier INRs	Attach.		
					concession established INR	incorporated in a GATT Schedule		Attach. A-A-Sect. 1	Attach. A-A-Sect. 2	Attach. A-A-Sect. B
3818 00	Chemical elements doped for use in electronics, in the form of discs, wafers or similar forms; chemical compounds doped for use in electronics				WT/Let		0.0			
3818 00 10	- Doped silicon	6.9	0.0	2000	WT/Let		0.0	1		
3818 00 90	- Other	6.9	0.0	2000	WT/Let		0.0	1		
7020 00	Other articles of glass				WT/Let		0.0			
7020 00 05	- Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	4	0.0	2000	WT/Let		0.0		113	
7020 00 10	- Of fused quartz or other fused silica				WT/Let		0.0			
7020 00 30	- Of glass having a linear coefficient of expansion not exceeding 5 x 10 ⁻⁶ per Kelvin within a temperature range of 0 °C to 300 °C				WT/Let		0.0			
7020 00 80	- Other				WT/Let		0.0			
8419	Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilizing, pasteurizing, steaming, drying, evaporating, vapourizing, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non-electric :				WT/Let		0.0			
8419 89	-- Other				WT/Let		0.0			
8419 89 10	--- Cooling towers and similar plant for direct cooling (without a separating wall) by means of recirculated water				WT/Let		0.0			
8419 89 15	--- Apparatus for rapid heating of semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		162	
8419 89 20	--- Apparatus for chemical vapour deposition on semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		114	
8419 89 25	--- Apparatus for physical vapour deposition by electronic beam or evaporation on semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		141	
8419 89 30	--- Vacuum-vapour plant for the deposition of metal				WT/Let		0.0			
8419 89 95	--- Other				WT/Let		0.0			

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Sect. 1</u>	<u>Sect. 2</u>	<u>Sect. B</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	
8419 90	- Parts				WT/Let			0.0	
8419 90 10	-- Of heat exchange units, for use in civil aircraft				WT/Let			0.0	
8419 90 20	-- Of subheading 8419 20 00				WT/Let			0.0	
8419 90 30	-- For apparatus of subheading 8419 89 15 to 8419 89 25	2.7	0.0	2000	WT/Let			0.0	115,15 8,164
8419 90 80	-- Other				WT/Let			0.0	
8421	Centrifuges, including centrifugal dryers; filtering or purifying machinery and apparatus, for liquids or gases :				WT/Let			0.0	
8421 19	-- Other				WT/Let			0.0	
8421 19 10	--- For use in civil aircraft				WT/Let			0.0	
	--- Other				WT/Let			0.0	
8421 19 91	---- Centrifuges of a kind used in laboratories				WT/Let			0.0	
	---- Centrifuges of a kind used in the manufacturing of semiconductors wafers:				WT/Let			0.0	
8421 19 93	----- Spinners for coating photographic emulsions on semiconductor wafers	0.0	0.0	1997	WT/Let			0.0	148
8421 19 95	----- Other	1.5	0.0	2000	WT/Let			0.0	116
8421 19 97	---- Other				WT/Let			0.0	
	- Parts				WT/Let			0.0	
	-- Of centrifuges, including centrifugal dryers				WT/Let			0.0	
8421 91 10	--- For apparatus of subheading 8421 19 93 or 8421 19 95	2.5	0.0	2000	WT/Let			0.0	117,15 1
8421 91 90	--- Other				WT/Let			0.0	
8421 99 00	-- Other				WT/Let			0.0	
8424	Mechanical appliances (whether or not hand-operated) for projecting, dispersing or spraying liquids or powders; fire extinguishers, whether or not charged; spray guns and similar appliances; steam or sand blasting machines and similar jet projecting machines :				WT/Let			0.0	
8424 89	-- Other				WT/Let			0.0	
8424 89 20	--- Spraying appliances for etching, stripping or cleaning semiconductor wafers	0.0	0.0	1997	WT/Let			0.0	119
8424 89 30	--- Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	2.8	0.0	2000	WT/Let			0.0	118
8424 89 80	--- Other				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Annex</u>	<u>Annex</u>	<u>Annex</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8424 90	- Parts				WT/Let			0.0	
8424 90 10	-- Of apparatus of subheading 8424 89 20	2.8	0.0	2000	WT/Let			0.0	120
8424 90 90	-- Other				WT/Let			0.0	
8428	Other lifting, handling, loading or unloading machinery (for example, lifts, escalators, conveyors, teleferics) :				WT/Let			0.0	
8428 39	-- Other				WT/Let			0.0	
8428 39 10	--- For use in civil aircraft				WT/Let			0.0	
	--- Other				WT/Let			0.0	
8428 39 91	---- Roller conveyors				WT/Let			0.0	
8428 39 93	---- Automated material handling machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0.0	0.0	1997	WT/Let			0.0	139
8428 39 98	---- Other				WT/Let			0.0	
8431	Parts suitable for use solely or principally with the machinery of heading Nos 8425 to 8430 :				WT/Let			0.0	
8431 39	-- Other				WT/Let			0.0	
8431 39 10	--- Of rolling-mill machinery of subheading 8428 90 30				WT/Let			0.0	
8431 39 20	--- Of machinery of subheading 8428 39 93	1.6	0.0	1999	WT/Let			0.0	154
8431 39 80	--- Other				WT/Let			0.0	
8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes :				WT/Let			0.0	
8456 10	- Operated by laser or other light or photon beam processes				WT/Let			0.0	
8456 10 10	-- Of a kind used in the manufacturing of semiconductor wafers or devices	4.7	0.0	2000	WT/Let			0.0	121,12 5
8456 10 90	-- Other				WT/Let			0.0	
8456 91 00	-- For dry-etching patterns on semiconductor materials	0.0	0.0	1997	WT/Let			0.0	123
8456 99	-- Other				WT/Let			0.0	
8456 99 10	--- Focused ion beam milling machines for producing or repairing masks and reticles for patterns on semiconductor devices	0.0	0.0	1997	WT/Let			0.0	124
8456 99 30	--- Apparatus for stripping or cleaning semiconductor wafers	0.0	0.0	1997	WT/Let			0.0	122

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Annex</u>	<u>Annex</u>	<u>Annex</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8456 99 90	--- Other				WT/Let			0.0	
8462	Machine-tools (including presses) for working metal by forging, hammering or die-stamping; machine-tools (including presses) for working metal by bending, folding, straightening, flattening, shearing, punching or notching; presses for working metal or metal carbides, not specified above :				WT/Let			0.0	
	- Bending, folding, straightening or flattening machines (including presses)				WT/Let			0.0	
8462 21	-- Numerically controlled				WT/Let			0.0	
8462 21 05	--- Of a kind used in manufacturing semiconductor devices	3.2	0.0	2000	WT/Let			0.0	146
8462 21 10	--- For working flat products				WT/Let			0.0	
8462 21 80	--- Other				WT/Let			0.0	
8462 29	-- Other				WT/Let			0.0	
8462 29 05	--- Of a kind used in manufacturing semiconductor devices	1.7	0.0	2000	WT/Let			0.0	146
8462 29 10	--- For working flat products				WT/Let			0.0	
	--- Other				WT/Let			0.0	
8462 29 91	--- Hydraulic				WT/Let			0.0	
8462 29 99	--- Other				WT/Let			0.0	
8464	Machine-tools for working stone, ceramics, concrete, asbestos- cement or like mineral materials or for cold working glass :				WT/Let			0.0	
8464 10	- Sawing machines				WT/Let			0.0	
8464 10 10	-- For sawing monocrystal semiconductor boules into slices, or wafers into chips	0.0	0.0	1997	WT/Let			0.0	126
8464 10 90	-- Other				WT/Let			0.0	
8464 20	- Grinding or polishing machines				WT/Let			0.0	
8464 20 05	-- For working semiconductor wafers	0.0	0.0	1997	WT/Let			0.0	127
	-- For working glass				WT/Let			0.0	
8464 20 11	--- Optical glass				WT/Let			0.0	
8464 20 19	--- Other				WT/Let			0.0	
8464 20 80	-- Other				WT/Let			0.0	
8464 90	- Other				WT/Let			0.0	
8464 90 10	-- For scribing or scoring semiconductor wafers	0.0	0.0	1997	WT/Let			0.0	128
8464 90 90	-- Other				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Attch. A</u>	<u>Attch. A</u>	<u>Attch. A</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8466	Parts and accessories suitable for use solely or principally with the machines of heading Nos 8456 to 8465, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine-tools; tool holders for any type of tool for working in the hand :				WT/Let			0.0	
	- Other				WT/Let			0.0	
8466 91	-- For machines of heading No 8464				WT/Let			0.0	
8466 91 15	--- For machines of subheading 8464 10 10, 8464 20 05 or 8464 90 10	1.9	0.0	2000	WT/Let			0.0	129,13 0,131
8466 91 20	--- Of cast iron or cast steel				WT/Let			0.0	
8466 91 95	--- Other				WT/Let			0.0	
8466 93	-- For machines of heading Nos 8456 to 8461				WT/Let			0.0	
8466 93 15	--- For machines and apparatus of subheading 8456 10 10, 8456 91 00, 8456 99 10 or 8456 99 30	1.9	0.0	2000	WT/Let			0.0	134,13 6,132,1 35,133
8466 93 20	--- Of cast iron or cast steel				WT/Let			0.0	
8466 93 95	--- Other				WT/Let			0.0	
8466 94	-- For machines of heading No 8462 or 8463				WT/Let			0.0	
8466 94 10	--- For machines of subheading 8462 21 05 or 8452 29 05	1.9	0.0	2000	WT/Let			0.0	157
8466 94 90	--- Other				WT/Let			0.0	
	- Automatic typewriters and word-processing machines				WT/Let			0.0	
8469 11 00	-- Word-processing machines	3.2	0.0	2000	WT/Let			0.0	2
8470	Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers :				WT/Let			0.0	
8470 10	- Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions				WT/Let			0.0	
8470 10 10	-- Electronic calculators capable of operation without an external source of electric power	8.4	0.0	2000	WT/Let			0.0	3

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>	ODCs	Sect. 1	2	Attach.- Sect. B
					<u>concession</u> established INR	<u>incorporated in a</u> GATT Schedule	<u>Earlier INRs</u>				
8470 10 90 --	Pocket-size data recording, reproducing and displaying machines with calculating functions	5.0	0.0	2000	WT/Let		0.0	3			
	- Other electronic calculating machines				WT/Let		0.0				
8470 21 00 --	Incorporating a printing device	8.4	0.0	2000	WT/Let		0.0	4			
8470 29 00 --	Other	8.4	0.0	2000	WT/Let		0.0	5			
8470 30 00 -	Other calculating machines	2.8	0.0	2000	WT/Let		0.0	6			
8470 40 00 -	Accounting machines	2.8	0.0	2000	WT/Let		0.0	7			
8470 50 00 -	Cash registers	2.8	0.0	2000	WT/Let		0.0	8			
8470 90 00 -	Other	2.8	0.0	2000	WT/Let		0.0	9			
8471	Automatic data-processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included :				WT/Let		0.0				
8471 10	- Analogue or hybrid automatic data-processing machines				WT/Let		0.0				
8471 10 10 --	For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	10			
8471 10 90 --	Other	3.5	0.0	2000	WT/Let		0.0	10			191,
8471 30 00 -	Portable digital automatic data-processing machines, weighing not more than 10 kg, consisting of at least a central processing unit, a keyboard and a display	3.5	0.0	2000	WT/Let		0.0	11			191,
	- Other digital automatic data-processing machines				WT/Let		0.0				
8471 41	-- Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined				WT/Let		0.0				
8471 41 10 ---	For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	12			
8471 41 90 ---	Other	3.5	0.0	2000	WT/Let		0.0	12			191,
8471 49	-- Other, presented in the form of systems				WT/Let		0.0				
8471 49 10 ---	For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	13			
8471 49 90 ---	Other	3.5	0.0	2000	WT/Let		0.0	13			191,
8471 50	- Digital processing units other than those of subheadings No 8471 41 and 8471 49, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units				WT/Let		0.0				
8471 50 10 --	For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	14			
8471 50 90 --	Other	3.5	0.0	2000	WT/Let		0.0	14			191,194

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Earlier INRs	Attach.		
					concession established INR	incorporated in a GATT Schedule		Attach. A-A-Sect. 1	Attach. A-A-Sect. 2	Attach. A-A-Sect. B
8471 60	- Input or output units, whether or not containing storage units in the same housing				WT/Let		0.0			
8471 60 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	15		
	-- Other				WT/Let		0.0			
8471 60 40	--- Printers	2	0.0	1999	WT/Let		0.0	15		
8471 60 50	--- Keyboards	2	0.0	1999	WT/Let		0.0	15		
8471 60 90	--- Other	2	0.0	1999	WT/Let		0.0	15		194,195
8471 70	- Storage units				WT/Let		0.0			
8471 70 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	16		
	-- Other				WT/Let		0.0			
8471 70 40	--- Central storage units	2	0.0	1999	WT/Let		0.0	16		
	--- Other				WT/Let		0.0			
	---- Disk storage units				WT/Let		0.0			
8471 70 51	----- Optical, including magneto-optical	2	0.0	1999	WT/Let		0.0	16		196,201
	----- Other				WT/Let		0.0			,
8471 70 53	----- Hard disk drives	1.6	0.0	1999	WT/Let		0.0	16		201,
8471 70 59	----- Other	2	0.0	1999	WT/Let		0.0	16		201,
8471 70 60	----- Magnetic tape storage units	2	0.0	1999	WT/Let		0.0	16		201,
8471 70 90	----- Other	2	0.0	1999	WT/Let		0.0	16		201,
8471 80	- Other units of automatic data-processing machines				WT/Let		0.0			
8471 80 10	-- Peripheral units	2	0.0	1999	WT/Let		0.0	17		
8471 80 90	-- Other	2	0.0	1999	WT/Let		0.0	17		198,
8471 90 00	- Other	2	0.0	1999	WT/Let		0.0	18		
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin-counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines) :				WT/Let		0.0			
8472 90	- Other				WT/Let		0.0			
8472 90 10	-- Coin-sorting, coin-counting or coin-wrapping machines				WT/Let		0.0			
8472 90 30	-- Automatic teller machines	3.1	0.0	2000	WT/Let		0.0	19		
8472 90 80	-- Other				WT/Let		0.0			
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of heading Nos 8469 to 8472 :				WT/Let		0.0			
8473 10	- Parts and accessories of the machines of heading No 8469				WT/Let		0.0			

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					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A-A-Sect.</u>	<u>Attach.-</u>	<u>B</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	
8473 10 11 --	Printed circuit assemblies for products of subheading No 8469 11	3.4	0.0	2000	WT/Let			0.0	199,
8473 10 19 --	Other				WT/Let			0.0	
8473 21 --	Of the electronic calculating machines of subheading 8470 10, 8470 21 or 8470 29				WT/Let			0.0	
8473 21 10 ---	Electronic assemblies	4.3	0.0	2000	WT/Let			0.0	20
8473 21 90 ---	Other	2.5	0.0	1999	WT/Let			0.0	20
8473 29 --	Other				WT/Let			0.0	
8473 29 10 ---	Electronic assemblies	3.4	0.0	2000	WT/Let			0.0	21
8473 29 90 ---	Other	1.6	0.0	1999	WT/Let			0.0	21
8473 30 -	Parts and accessories of the machines of heading No 8471				WT/Let			0.0	
8473 30 10 --	Electronic assemblies	3.3	0.0	2000	WT/Let			0.0	22
8473 30 90 --	Other	1.6	0.0	1999	WT/Let			0.0	22
8473 40 -	Parts and accessories of the machines of heading No 8472				WT/Let			0.0	
8473 40 11 --	Printed circuit assemblies for products of subheading 8472 90 30	3.4	0.0	2000	WT/Let			0.0	
8473 40 19 --	Other				WT/Let			0.0	
8473 50 -	Parts and accessories equally suitable for use with machines of two or more of the headings Nos 8469 to 8472				WT/Let			0.0	
8473 50 10 --	Electronic assemblies	3.4	0.0	2000	WT/Let			0.0	23
8473 50 90 --	Other	1.6	0.0	1999	WT/Let			0.0	23
8477	Machinery for working rubber or plastics or for the manufacture of products from these materials, not specified or included elsewhere in this chapter :				WT/Let			0.0	
8477 10 -	Injection-moulding machines				WT/Let			0.0	
8477 10 10 --	Encapsulation equipment for assembly of semiconductors	2.8	0.0	2000	WT/Let			0.0	
8477 10 90 --	Other				WT/Let			0.0	
8477 59 --	Other				WT/Let			0.0	
8477 59 05 ---	Encapsulation equipment for assembly of semiconductors	2.8	0.0	2000	WT/Let			0.0	
8477 59 10 ---	Presses				WT/Let			0.0	
8477 59 90 ---	Other				WT/Let			0.0	
8477 90 -	Parts				WT/Let			0.0	
8477 90 05 --	For machines of subheadings 8477 10 10 and 8477 59 05	2.8	0.0	2000	WT/Let			0.0	
8477 90 10 --	Of cast iron or cast steel				WT/Let			0.0	
8477 90 80 --	Other				WT/Let			0.0	

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					<u>concession</u>	<u>incorporated in a</u>		<u>Sect. 1</u>	<u>2</u>	<u>B</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>ODCs</u>			
8479	Machines and mechanical appliances having individual functions, not specified or included elsewhere in this chapter :				WT/Let		0.0			
8479 89	-- Other				WT/Let		0.0			
8479 89 10	--- The following goods, for use in civil aircraft : Hydropneumatic batteries; Mechanical actuators for thrust reversers; Toilet units specially designed; Air humidifiers and dehumidifiers; Servo-mechanisms, non-electric; Non-electric starter motors; Pneumatic starters for turbo-jets, turbo-jets, turbo-propellers and other gas turbines; Windscreen wipers, non-electric; Propeller regulators, non-electric				WT/Let		0.0			
	--- Other				WT/Let		0.0			
8479 89 30	---- Mobile hydraulic powered mine roof supports				WT/Let		0.0			
8479 89 60	---- Central greasing systems				WT/Let		0.0			
8479 89 65	---- Apparatus for growing or pulling monocrystal semiconductor boules	0.0	0.0	1997	WT/Let		0.0		140	
8479 89 70	---- Apparatus for epitaxial deposition on semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		145	
8479 89 75	---- Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		142,168	
8479 89 76	---- Apparatus for wet etching, developing, stripping or cleaning liquid crystal display substrates	2.8	0.0	2000	WT/Let		0.0		142,168	
8479 89 77	---- Die attach apparatus and tape automated bonders for the assembly of semiconductors	2.8	0.0	2000	WT/Let		0.0		143	
8479 89 79	---- Encapsulation equipment for assembly of semiconductors	2.8	0.0	2000	WT/Let		0.0		144	
8479 89 95	---- Other				WT/Let		0.0			
8479 90	- Parts				WT/Let		0.0			
8479 90 10	-- For use in civil aircraft				WT/Let		0.0			
	-- Other				WT/Let		0.0			
8479 90 50	--- Of machines of subheadings 8479 89 65, 8479 89 70, 8479 89 75, 8479 89 76, 8479 89 77 or 8479 89 79	2.8	0.0	2000	WT/Let		0.0		152,156,153,150,155,169	
8479 90 92	--- Of cast iron or cast steel				WT/Let		0.0			
8479 90 98	--- Other				WT/Let		0.0			

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					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>A-Sect.</u>	<u>Attach.-</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8480	Moulding boxes for metal foundry; mould bases; moulding patterns; moulds for metal (other than ingot moulds), metal carbides, glass, mineral materials, rubber or plastics :				WT/Let			0.0	
	- Moulds for rubber or plastics				WT/Let			0.0	
8480 71	-- Injection or compression types				WT/Let			0.0	
8480 71 10	--- of a kind used in the manufacturing of semiconductor devices	2.5	0.0	2000	WT/Let			0.0	159
8480 71 90	--- Other				WT/Let			0.0	
8504	Electrical transformers, static converters (for example, rectifiers) and inductors :				WT/Let			0.0	
8504 40	- Static converters				WT/Let			0.0	
8504 40 10	-- For use in civil aircraft				WT/Let			0.0	
	-- Other				WT/Let			0.0	
	--- Of a kind used with telecommunication apparatus and automatic data-processing machines and units thereof :				WT/Let			0.0	
8504 40 30	---- Power supply units of a kind used with automatic data-processing machines	2	0.0	1999	WT/Let			0.0	24
8504 40 35	---- Other	4.6	0.0	2000	WT/Let			0.0	24
	--- Other				WT/Let			0.0	
8504 40 50	---- Polycrystalline semiconductors				WT/Let			0.0	
	---- Other				WT/Let			0.0	
8504 40 93	----- Accumulator chargers				WT/Let			0.0	
	----- Other				WT/Let			0.0	
8504 40 94	----- Rectifiers				WT/Let			0.0	
	----- Inverters				WT/Let			0.0	
8504 40 96	----- Having a power handling capacity not exceeding 7,5 kVA				WT/Let			0.0	
8504 40 97	----- Having a power handling capacity exceeding 7,5 kVA				WT/Let			0.0	
8504 40 99	----- Other				WT/Let			0.0	
8504 50	- Other inductors				WT/Let			0.0	
8504 50 10	-- For use in civil aircraft				WT/Let			0.0	
	-- Other				WT/Let			0.0	
8504 50 30	--- Of a kind used for telecommunication apparatus and power supplies for automatic data processing machines and units thereof	4.8	0.0	2000	WT/Let			0.0	25
8504 50 80	--- Other				WT/Let			0.0	
8504 90	- Parts				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A-A-Sect.</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>
							<u>ODCs</u>
							<u>Sect. 1</u>
							<u>2</u>
							<u>B</u>
	-- Of transformers and inductors				WT/Let		0.0
8504 90 05	---- Printed circuit assemblies for products of subheading 8504 50 30	3.1	0.0	2000	WT/Let		0.0
	--- Other				WT/Let		0.0
8504 90 11	---- Ferrite cores				WT/Let		0.0
8505 90 18	--- Other				WT/Let		0.0
	-- Of static converters				WT/Let		0.0
8504 90 91	---- Printed circuits assemblies for products of subheadings 8504 40 30 and 8504 40 35	3.1	0.0	2000	WT/Let		0.0
8504 90 99	---- Other				WT/Let		0.0
8514	Industrial or laboratory electric (including induction or dielectric) furnaces and ovens; other industrial or laboratory induction or dielectric heating equipment :				WT/Let		0.0
8514 10	- Resistance heated furnaces and ovens				WT/Let		0.0
8514 10 05	-- For the manufacture of semiconductor devices on semiconductor wafers	3	0.0	2000	WT/Let		0.0
	-- Other				WT/Let		0.0
8514 10 10	--- Bakery and biscuit ovens				WT/Let		0.0
8514 10 90	--- Other				WT/Let		0.0
8514 20	- Induction or dielectric furnaces and ovens				WT/Let		0.0
8514 20 05	-- For the manufacture of semiconductor devices on semiconductor wafers	3	0.0	2000	WT/Let		0.0
	--- Other				WT/Let		0.0
8514 20 10	-- Induction furnaces and ovens				WT/Let		0.0
8514 20 90	-- Dielectric furnaces and ovens				WT/Let		0.0
8514 30	- Other furnaces and ovens				WT/Let		0.0
	-- Infra-red radiation ovens				WT/Let		0.0
8514 30 11	--- For the manufacture of semiconductor devices on semiconductor wafers	0.0	0.0	1997	WT/Let		0.0
8514 30 19	--- Other				WT/Let		0.0
	-- Other				WT/Let		0.0
8514 30 91	--- For the manufacture of semiconductor devices on semiconductor wafers	0.0	0.0	1997	WT/Let		0.0
8514 30 99	--- Other				WT/Let		0.0
8514 90	- Parts				WT/Let		0.0
8514 90 10	-- Of apparatus of subheading 8514 10 05, 8514 20 05, 8514 30 11 or 8514 30 91	3	0.0	2000	WT/Let		0.0
8514 90 90	-- Other				WT/Let		0.0

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	Earlier INRs	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>		<u>Sect. 1</u>	<u>2</u>	<u>B</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>ODCs</u>			
8515	Electric (including electrically heated gas), laser or other light or photon beam, ultrasonic, electron beam, magnetic pulse or plasma arc soldering, brazing or welding machines and apparatus, whether or not capable of cutting; electric machines and apparatus for hot spraying of metals or cermets				WT/Let		0.0			
	- Brazing or soldering machines and apparatus				WT/Let		0.0			
8515 11 00 --	Soldering irons and guns				WT/Let		0.0			
8515 19 00 --	Other				WT/Let		0.0			
	- Machines and apparatus for resistance welding of metal				WT/Let		0.0			
8515 21 00 --	Fully or partly automatic				WT/Let		0.0			
8515 29 --	Other				WT/Let		0.0			
8515 29 10 ---	For butt welding				WT/Let		0.0			
8515 29 90 ---	Other				WT/Let		0.0			
	- Machines and apparatus for arc (including plasma arc) welding of metals				WT/Let		0.0			
8515 31 00 --	Fully or partly automatic				WT/Let		0.0			
8515 39 --	Other				WT/Let		0.0			
	--- For manual welding with coated electrodes, complete with welding or cutting devices, and consigned with				WT/Let		0.0			
8515 39 13 ----	Transformers				WT/Let		0.0			
8515 39 18 ----	Generators or rotary converters or static converters, rectifiers or rectifying apparatus				WT/Let		0.0			
8515 39 90 ---	Other				WT/Let		0.0			
8515 80 -	Other machines and apparatus				WT/Let		0.0			
8515 80 05 --	Wire bonders of a kind used for manufacturing semiconductor devices	3.7	0.0	2000	WT/Let		0.0		143	
	-- Other				WT/Let		0.0			
	--- For treating metals				WT/Let		0.0			
8515 80 11 ----	For welding				WT/Let		0.0			
8515 80 19 ----	Other				WT/Let		0.0			
	--- Other				WT/Let		0.0			
8515 80 91 ----	For resistance welding of plastics				WT/Let		0.0			
8515 80 99 ----	Other				WT/Let		0.0			
8515 90 -	Parts				WT/Let		0.0			
8515 90 10 --	For machines of subheading 8515 80 05	3.7	0.0	2000	WT/Let		0.0		143	
8515 90 90 --	Other				WT/Let		0.0			

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>A-Sect.</u>	<u>Attach.-</u>
					<u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8517	Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier -current line systems or for digital line systems; videophones :				WT/Let			0.0	
	- Telephone sets; videophones				WT/Let			0.0	
8517 11 00 --	Line telephone sets with cordless handsets	7.5	0.0	2000	WT/Let			0.0	26
8517 19 --	Other				WT/Let			0.0	
8517 19 10 ---	Videophones	14	0.0	2000	WT/Let			0.0	27
8517 19 90 ---	Other	7.5	0.0	2000	WT/Let			0.0	27
	- Facsimile machines and teleprinters				WT/Let			0.0	
8517 21 00 --	Facsimile machines	7.5	0.0	2000	WT/Let			0.0	28
8517 22 00 --	Teleprinters	7.5	0.0	2000	WT/Let			0.0	29
8517 30 00 -	Telephonic or telegraphic switching apparatus	7.5	0.0	2000	WT/Let			0.0	30
8517 50 -	Other apparatus, for carrier-current line systems or for digital line systems				WT/Let			0.0	
8517 50 10 --	For carrier-current line systems	4.6	0.0	2000	WT/Let			0.0	31
8517 50 90 --	Other	7.5	0.0	2000	WT/Let			0.0	31
8517 80 -	Other apparatus				WT/Let			0.0	
8517 80 10 --	Entry-phone systems	7.5	0.0	2000	WT/Let			0.0	32
8517 80 90 --	Other	7.5	0.0	2000	WT/Let			0.0	32
8517 90 -	Parts				WT/Let			0.0	
	-- Of apparatus for carrier-current line systems of subheading 8517 50 10				WT/Let			0.0	
8517 90 11 ---	Electronic assemblies	3.6	0.0	2000	WT/Let			0.0	33
8517 90 19 ---	Other	3.6	0.0	2000	WT/Let			0.0	33
	-- Other				WT/Let			0.0	
8517 90 82 ---	Electronic assemblies	4.8	0.0	2000	WT/Let			0.0	33
8517 90 88 ---	Other	4.8	0.0	2000	WT/Let			0.0	33
8518	Microphones and stands therefor; loudspeakers, whether or not mounted in their enclosures; headphones, earphones and combined microphone/speaker sets; audio- frequency electric amplifiers; electric sound amplifier sets :				WT/Let			0.0	
8518 10 -	Microphones and stands therefor				WT/Let			0.0	
8518 10 10 --	For use in civil aircraft				WT/Let			0.0	
	-- Other				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	Earlier INRs	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>		<u>Sect. 1</u>	<u>2</u>	<u>B</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>ODCs</u>			
8518 10 20 ---	Microphones having a frequency range of 300 Hz to 3.4 KHz with a diameter not exceeding 10 mm and a height not exceeding 3 mm, for telecommunications use	3.5	0.0	2000	WT/Let		0.0	34		
8518 10 80 ---	Other				WT/Let		0.0			
8518 29 --	Other				WT/Let		0.0			
8518 29 10 ---	For use in civil aircraft				WT/Let		0.0			
8518 29 20 ---	Loudspeakers having a frequency range of 300 Hz to 3.4 KHz with a diameter not exceeding 50 mm, for telecommunications use	3.8	0.0	2000	WT/Let		0.0	36		
8518 29 80 ---	Other				WT/Let		0.0			
8518 30 -	Headphones, earphones and combined microphone/speaker sets				WT/Let		0.0			
8518 30 10 --	For use in civil aircraft				WT/Let		0.0			
8518 30 20 --	Line telephone handsets	4	0.0	2000	WT/Let		0.0	35		
8518 30 80 --	Other				WT/Let		0.0			
8520	Magnetic tape recorders and other sound recording apparatus, whether or not incorporating a sound reproducing device :				WT/Let		0.0			
8520 20 00 -	Telephone answering machines	5.2	0.0	2000	WT/Let		0.0	37		
8522	Parts and accessories suitable for use solely or principally with the apparatus of headings Nos 8519 to 8521				WT/Let		0.0			
8522 10 00 -	Pick-up cartridges				WT/Let		0.0			
8522 90 -	Other				WT/Let		0.0			
8522 90 10 --	Assemblies and sub-assemblies consisting of two or more parts or pieces fastened or joined together, for apparatus falling within subheading 8520 90, for use in civil aircraft				WT/Let		0.0			
	-- Other				WT/Let		0.0			
8522 90 30 ---	Styli; diamonds, sapphires and other precious or semi-precious stones (natural, synthetic or reconstructed) for styli, whether or not mounted				WT/Let		0.0			
	--- Other				WT/Let		0.0			
	---- Electronic assemblies				WT/Let		0.0			
8522 90 51 -----	Printed circuit assemblies for products of subheading 8520 20 00	4.7	0.0	2000	WT/Let		0.0		199,	
8522 90 59 -----	Other				WT/Let		0.0			

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A-A-Sect.</u>	<u>Attach.-</u>	
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8522 90 93 ----	Single cassette-deck assemblies with a total thickness not exceeding 53 mm, of a kind used in the manufacture of sound recording and reproducing apparatus				WT/Let			0.0	
8522 90 98 ----	Other				WT/Let			0.0	
8523	Prepared unrecorded media for sound recording or similar recording of other phenomena, other than products of Chapter 37 :				WT/Let			0.0	
	- Magnetic tapes				WT/Let			0.0	
8523 11 00 --	Of a width not exceeding 4 mm	3.2	0.0	2000	WT/Let			0.0	38
8523 12 00 --	Of a width exceeding 4 mm but not exceeding 6,5 mm	4.1	0.0	2000	WT/Let			0.0	39
8523 13 00 --	Of a width exceeding 6,5 mm	4.1	0.0	2000	WT/Let			0.0	40
8523 20	- Magnetic discs				WT/Let			0.0	
	-- Rigid				WT/Let			0.0	
8523 20 11 ----	With a thin film metallic coating, having a coercivity exceeding 600 Oersted and an external diameter not exceeding 231 mm	2	0.0	1999	WT/Let			0.0	41
									201,
8523 20 19 ---	Other	4.1	0.0	2000	WT/Let			0.0	41
									201,
8523 20 90 --	Other	4.1	0.0	2000	WT/Let			0.0	41
									201,
8523 90 00 -	Other	4.1	0.0	2000	WT/Let			0.0	42
									201,
8524	Records, tapes and other recorded media for sound or other similarly recorded phenomena, including matrices and masters for the production of records, but excluding products of Chapter 37 :				WT/Let			0.0	
	- Discs for laser reading systems				WT/Let			0.0	
8524 31 00 --	For reproducing phenomena other than sound or image	4.1	0.0	2000	WT/Let			0.0	43
									201,
8524 32 00 --	For reproducing sound only				WT/Let			0.0	
8524 39	-- Other				WT/Let			0.0	
8524 39 10 ----	For reproducing representations of instructions, data, sound and image recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to the user, by means of an automatic data processing machine	4.1	0.0	2000	WT/Let			0.0	44
									201,
8524 39 90 ---	Other				WT/Let			0.0	
8524 40	- Magnetic tapes for reproducing phenomena other than sound or image				WT/Let			0.0	
8524 40 10 --	Bearing data or instructions of a kind used in automatic data-processing machines	2	0.0	1999	WT/Let			0.0	45
									201,

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Earlier INRs	Attach.		
					concession established INR	incorporated in a GATT Schedule		Attach. A-A-Sect. 1	Attach. A-A-Sect. 2	Attach. A-A-Sect. B
	-- Other				WT/Let		0.0			
8524 40 91	--- Of a width exceeding 4 mm but not exceeding 6,5 mm	3.6	0.0	2000	WT/Let		0.0	45		201,
8524 40 99	--- Other	4.1	0.0	2000	WT/Let		0.0	45		201,
	- Other				WT/Let		0.0			
8524 91	-- For reproducing phenomena other than sound or image				WT/Let		0.0			
8524 91 10	--- Bearing data or instructions of a kind used in automatic data-processing machines	2	0.0	1999	WT/Let		0.0	46		201,
8524 91 90	--- Other	4.1	0.0	2000	WT/Let		0.0	46		201,
8524 99	-- Other				WT/Let		0.0			
8524 99 10	--- For reproducing representations of instructions, data, sound and image recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to the user, by means of an automatic data processing machine	4.1	0.0	2000	WT/Let		0.0	47		201,
8524 99 90	--- Other				WT/Let		0.0			
8525	Transmission apparatus for radio-telephony, radio-telegraphy, radio-broadcasting or television, whether or not incorporating reception apparatus or sound recording or reproducing apparatus; television cameras; still image video cameras and other video camera recorders :				WT/Let		0.0			
8525 10	- Transmission apparatus				WT/Let		0.0			
	-- Radio-telegraphic or radio-telephonic apparatus:				WT/Let		0.0			
8525 10 10	--- for use in civil aircraft				WT/Let		0.0			
8525 10 50	---- Radio-telegraphic or radio-telephonic apparatus	4.1	0.0	2000	WT/Let		0.0	48		
8525 10 80	---- Other				WT/Let		0.0			
8525 20	- Transmission apparatus incorporating reception apparatus				WT/Let		0.0			
8525 20 10	-- Radio-telegraphic or radio-telephonic apparatus, for use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	49		
	-- Other				WT/Let		0.0			
8525 20 91	--- For cellular networks (mobile telephones)	6.5	0.0	2000	WT/Let		0.0	49		
8525 20 99	--- Other	6.5	0.0	2000	WT/Let		0.0	49		203,
8525 40	- Still image video cameras and other video camera recorders				WT/Let		0.0			
	-- Still image video cameras				WT/Let		0.0			
8525 40 11	--- Digital	4.9	0.0	2000	WT/Let		0.0	50		

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8525 40 19	--- Other				WT/Let			0.0	
	-- Other video camera recorders				WT/Let			0.0	
8525 40 91	--- Only able to record sound and images taken by the television camera				WT/Let			0.0	
8525 40 99	--- Other				WT/Let			0.0	
8527	Reception apparatus for radio-telephony, radio-telegraphy or radio-broadcasting, whether or not combined, in the same housing, with sound recording or reproducing apparatus or a clock :				WT/Let			0.0	
8527 90	- Other apparatus				WT/Let			0.0	
8527 90 10	-- For radio-telephony or radio-telegraphy, for use in civil aircraft				WT/Let			0.0	
	-- Other				WT/Let			0.0	
8527 90 92	--- Portable receivers for calling, alerting or paging	9.6	0.0	2000	WT/Let			0.0	51
8527 90 98	--- Other				WT/Let			0.0	
8528	Reception apparatus for television, whether or not incorporating radio-broadcast receivers or sound or video recording or reproducing apparatus; video monitors and video projectors :				WT/Let			0.0	
	- Reception apparatus for television, whether or not incorporating radio-broadcast receivers or sound or video recording or reproducing apparatus				WT/Let			0.0	
8528 12	-- Colour				WT/Let			0.0	
8528 12 10	--- Apparatus combined with an automatic data processing machine, freely programmable by the user	14	0.0	2000	WT/Let			0.0	
	--- Other				WT/Let			0.0	
	---- Television projection equipment				WT/Let			0.0	
8528 12 14	----- With scanning parameters not exceeding 625 lines				WT/Let			0.0	
	----- With scanning parameters exceeding 625 lines				WT/Let			0.0	
8528 12 16	----- With a vertical resolution of less than 700 lines				WT/Let			0.0	
8528 12 18	----- With a vertical resolution of 700 lines or more				WT/Let			0.0	
	---- Apparatus incorporating a video recorder or reproducer				WT/Let			0.0	
8528 12 22	----- With a screen width/height ratio less than 1,5				WT/Let			0.0	
8528 12 28	----- Other				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>A-Sect.</u>	<u>Attach.-</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
	---- Other				WT/Let			0.0	
	----- With integral tube				WT/Let			0.0	
	----- With a screen width/height ratio less than 1,5, with a diagonal measurement of the screen				WT/Let			0.0	
8528 12 52	----- Not exceeding 42 cm				WT/Let			0.0	
8528 12 54	----- Exceeding 42 cm but not exceeding 52 cm				WT/Let			0.0	
8528 12 56	----- Exceeding 52 cm but not exceeding 72 cm				WT/Let			0.0	
8528 12 58	----- Exceeding 72 cm				WT/Let			0.0	
	----- Other				WT/Let			0.0	
	----- With scanning parameters not exceeding 625 lines, with a diagonal measurement of the screen				WT/Let			0.0	
8528 12 62	----- Not exceeding 75 cm				WT/Let			0.0	
8528 12 66	----- Exceeding 75 cm				WT/Let			0.0	
	----- With scanning parameters not exceeding 625 lines				WT/Let			0.0	
8528 12 72	----- With a vertical resolution of less than 700 lines				WT/Let			0.0	
8528 12 76	----- With a vertical resolution of 700 lines or more				WT/Let			0.0	
	----- Other				WT/Let			0.0	
	----- With screen				WT/Let			0.0	
8528 12 81	----- With a screen width/height ratio less than 1,5				WT/Let			0.0	
8528 12 89	----- Other				WT/Let			0.0	
	----- Without screen				WT/Let			0.0	
	----- Video Tuners				WT/Let			0.0	
8528 12 90	----- Printed circuit assemblies for physical incorporation into an automatic data processing machine	14.0	0.0	2000	WT/Let			0.0	199,
	----- Other				WT/Let			0.0	
8528 12 92	----- Digital (including mixed digital and analogue)				WT/Let			0.0	
8528 12 94	----- Other				WT/Let			0.0	
8528 12 98	----- Other				WT/Let			0.0	
8528 13	-- Black and white or other monochrome				WT/Let			0.0	
8528 13 10	--- Apparatus combined with an automatic data processing machine, freely programmable by the user	6.8	0.0	2000	WT/Let			0.0	191,
8528 13 90	--- Other				WT/Let			0.0	
8528 30	- Video projectors				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>A-Sect.</u>	<u>Attach.-</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8528 30 05	-- Of the flat panel type, capable of displaying digital information generated by the central processing unit of an automatic data processing machine	14	0.0	2000	WT/Let			0.0	200,
	-- Other				WT/Let			0.0	
8528 30 20	--- Colour				WT/Let			0.0	
8528 30 90	--- Black and white or other monochrome				WT/Let			0.0	
8529	Parts suitable for use solely or principally with the apparatus of heading Nos 8525 to 8528 :				WT/Let			0.0	
8529 10	- Aerials and aerial reflectors of all kinds; parts suitable for use therewith				WT/Let			0.0	
8529 10 10	-- For use in civil aircraft				WT/Let			0.0	
	-- Other				WT/Let			0.0	
	--- Aerials				WT/Let			0.0	
8529 10 15	---- Aerials of a kind used with apparatus for radio-telephony and radio-telegraphic	5	0.0	2000	WT/Let			0.0	52
8529 10 20	---- Telescopic and whip-type aerials for portable apparatus or for apparatus for fitting in motor vehicles				WT/Let			0.0	
	---- Outside aerials for radio or television broadcast receivers				WT/Let			0.0	
8529 10 31	----- For reception via satellite				WT/Let			0.0	
8529 10 39	----- Other				WT/Let			0.0	
8529 10 40	----- Inside aerials for radio or television broadcast receivers, including built-in types				WT/Let			0.0	
8529 10 50	----- Other				WT/Let			0.0	
8529 10 70	--- Aerial filters and separators				WT/Let			0.0	
8529 10 80	--- Other				WT/Let			0.0	
8529 90	- Other				WT/Let			0.0	
8529 90 10	-- Assemblies and sub-assemblies consisting of two or more parts or pieces fastened or joined together, for apparatus falling within subheadings 8526 10 10, 8526 91 11, 8526 91 19 and 8526 92 10, for use in civil aircraft				WT/Let			0.0	
	-- Other				WT/Let			0.0	
8529 90 40	--- Parts of apparatus falling within subheadings 8525 10 50, 8525 20 99, 8525 40 11 or 8527 90 92	4.7	0.0	2000	WT/Let			0.0	53
	--- Cabinets and cases				WT/Let			0.0	197,199
8529 90 51	---- Of wood				WT/Let			0.0	
8529 90 59	---- Of other materials				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>					
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>A-Sect.</u>	<u>Attach.-</u>			
					<u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>	<u>2</u>	<u>B</u>
8529 90 70	--- Electronic assemblies				WT/Let				0.0			
	--- Other				WT/Let				0.0			
8529 90 81	---- For television cameras of subheading No 8525 30 and apparatus of heading Nos 8527 and 8528				WT/Let				0.0			
8529 90 89	---- Other				WT/Let				0.0			
8531	Electric sound or visual signalling apparatus (for example, bells, sirens, indicator panels, burglar or fire alarms), other than those of heading No 8512 or 8530 :				WT/Let				0.0			
8531 20	- Indicator panels incorporating liquid crystal devices (LCD) or light emitting diodes (LED)				WT/Let				0.0			
8531 20 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let				0.0	54		
	-- Other				WT/Let				0.0			
8531 20 30	--- Incorporating light emitting diodes (LED)	4.2	0.0	2000	WT/Let				0.0	54		193,
	--- Incorporating liquid crystal devices (LCD)				WT/Let				0.0			
	---- Incorporating active matrix liquid crystal devices (LCD)				WT/Let				0.0			
8531 20 51	----- Colour	4.2	0.0	2000	WT/Let				0.0	54		193,
8531 20 59	----- Black and white or other monochrome	4.2	0.0	2000	WT/Let				0.0	54		193,
8531 20 80	--- Other	4.2	0.0	2000	WT/Let				0.0	54		193,
8531 80	- Other apparatus				WT/Let				0.0			
8531 80 10	-- For use in civil aircraft				WT/Let				0.0			
	-- Other				WT/Let				0.0			
8531 80 30	--- Flat panel display devices	3.1	0.0	2000	WT/Let				0.0			193,200
8531 80 80	--- Other				WT/Let				0.0			
8531 90	- Parts				WT/Let				0.0			
8531 90 10	-- Of apparatus of subheading No 8531 20	4.2	0.0	2000	WT/Let				0.0	55		193,199
8531 90 30	-- Of apparatus of subheading 8531 80 30	4.2	0.0	2000	WT/Let				0.0	55		193,199
8531 90 80	-- Other				WT/Let				0.0			
8532	Electrical capacitors, fixed, variable or adjustable (pre-set) :				WT/Let				0.0			
8532 10 00	- Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not less than 0,5 kvar (power capacitors)	3.6	0.0	2000	WT/Let				0.0	56		
	- Other fixed capacitors				WT/Let				0.0			
8532 21 00	-- Tantalum	5	0.0	2000	WT/Let				0.0	57		
8532 22 00	-- Aluminium electrolytic	5	0.0	2000	WT/Let				0.0	58		

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
8532 23 00 --	Ceramic dielectric, single layer	3.6	0.0	2000	WT/Let			0.0	59
	-- Ceramic dielectric, multilayer				WT/Let			0.0	
8532 24 10 ---	With connecting leads	3.6	0.0	2000	WT/Let			0.0	60
8532 24 90 ---	Other	3.6	0.0	2000	WT/Let			0.0	60
8532 25 00 --	Dielectric of paper or plastics	3.6	0.0	2000	WT/Let			0.0	61
8532 29 00 --	Other	3.6	0.0	2000	WT/Let			0.0	62
8532 30 00 -	Variable or adjustable (pre-set) capacitors	5	0.0	2000	WT/Let			0.0	63
8532 90 00 -	Parts	4.7	0.0	2000	WT/Let			0.0	64
8533	Electrical resistors (including rheostats and potentiometers), other than heating resistors :				WT/Let			0.0	
8533 10 00 -	Fixed carbon resistors, composition or film types	3.7	0.0	2000	WT/Let			0.0	65
	- Other fixed resistors				WT/Let			0.0	
8533 21 00 --	For a power handling capacity not exceeding 20 W	3.7	0.0	2000	WT/Let			0.0	66
8533 29 00 --	Other	3.7	0.0	2000	WT/Let			0.0	67
	- Wirewound variable resistors, including rheostats and potentiometers				WT/Let			0.0	
8533 31 00 --	For a power handling capacity not exceeding 20 W	3.7	0.0	2000	WT/Let			0.0	68
8533 39 00 --	Other	3.7	0.0	2000	WT/Let			0.0	69
8533 40	- Other variable resistors, including rheostats and potentiometers				WT/Let			0.0	
8533 40 10 --	For a power handling capacity not exceeding 20 W	3.7	0.0	2000	WT/Let			0.0	70
8533 40 90 --	Other	3.7	0.0	2000	WT/Let			0.0	70
8533 90 00 -	Parts	3.7	0.0	2000	WT/Let			0.0	71
8534 00	Printed circuits				WT/Let			0.0	
	- Consisting only of conductor elements and contacts				WT/Let			0.0	
8534 00 11 --	Multiple circuits	5.2	0.0	2000	WT/Let			0.0	72
8534 00 19 --	Other	5.2	0.0	2000	WT/Let			0.0	72
8534 00 90 -	With other passive elements	5.2	0.0	2000	WT/Let			0.0	72
8536	Electrical apparatus for switching or protecting electrical circuits, or for making connections to or in electrical circuits (for example, switches, relays, fuses, surge suppressors, plugs, sockets, lamp-holders, junction boxes), for a voltage not exceeding 1 000 V :				WT/Let			0.0	
8536 50	- Other switches				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>					
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A-A-Sect.</u>	<u>Attach.-</u>				
					<u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>	<u>2</u>	<u>B</u>
8536 50 03	-- Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches)	3.2	0.0	2000	WT/Let				0.0	73		
8536 50 05	-- Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology)	3.2	0.0	2000	WT/Let				0.0	74		
8536 50 07	-- Electromechanical snap-action switches for a current not exceeding 11 amps	3.2	0.0	2000	WT/Let				0.0	75		
	-- Other				WT/Let				0.0			
	--- For a voltage not exceeding 60 V				WT/Let				0.0			
8536 50 11	---- Push-button switches				WT/Let				0.0			
8536 50 15	---- Rotary switches				WT/Let				0.0			
8536 50 19	---- Other				WT/Let				0.0			
8536 50 90	--- Other				WT/Let				0.0			
8536 69	-- Other				WT/Let				0.0			
8536 69 10	--- For co-axial cables	3.2	0.0	2000	WT/Let				0.0	76		
8536 69 30	--- For printed circuits	3.2	0.0	2000	WT/Let				0.0	76		
8536 69 90	--- Other				WT/Let				0.0			
8536 90	- Other apparatus				WT/Let				0.0			
8536 90 01	-- Prefabricated elements for electrical circuits				WT/Let				0.0			
8536 90 10	-- Connections and contact elements for wire and cables	3.2	0.0	2000	WT/Let				0.0	77		
8536 90 20	-- Wafer probers	0.0	0.0	1997	WT/Let				0.0		166	
8536 90 85	-- Other				WT/Let				0.0			
8541	Diodes, transistors and similar semiconductor devices; photosensitive semi- con- ductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light-emitting diodes; mounted piezo-electric crystals :				WT/Let				0.0			
8541 10	- Diodes, other than photosensitive or light-emitting diodes				WT/Let				0.0			
8541 10 10	-- Wafers not yet cut into chips	7	0.0	1999	WT/Let				0.0	78		
	-- Other				WT/Let				0.0			
8541 10 91	--- Power rectifier diodes	7	0.0	1999	WT/Let				0.0	78		
8541 10 99	--- Other	7	0.0	1999	WT/Let				0.0	78		
	- Transistors, other than photosensitive transistors				WT/Let				0.0			
8541 21	-- With a dissipation rate of less than 1 W				WT/Let				0.0			
8541 21 10	--- Wafers not yet cut into chips	7	0.0	1999	WT/Let				0.0	79		

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A-A-Sect. Attach.-</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>B</u>
					<u>established</u>	<u>GATT Schedule</u>			
8541 21 90 ---	Other	7	0.0	1999	WT/Let		0.0	79	
8541 29 --	Other				WT/Let		0.0		
8541 29 10 ---	Wafers not yet cut into chips	7	0.0	1999	WT/Let		0.0	80	
8541 29 20 ---	PowerMOS field effective transistors	7	0.0	1999	WT/Let		0.0	80	
8541 29 30 ---	Insulated gate bipolar transistors (IGBTs)	7	0.0	1999	WT/Let		0.0	80	
8541 29 80 ---	Other	7	0.0	1999	WT/Let		0.0	80	
8541 30 -	Thyristors, diacs and triacs, other than photosensitive devices				WT/Let		0.0		
8541 30 10 --	Wafers not yet cut into chips	7	0.0	1999	WT/Let		0.0	81	
8541 30 90 --	Other	7	0.0	1999	WT/Let		0.0	81	
8541 40 -	Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light-emitting diodes				WT/Let		0.0		
--	Light-emitting diodes				WT/Let		0.0		
8541 40 11 ---	Laser diodes	7	0.0	1999	WT/Let		0.0	82	
8541 40 19 ---	Other	7	0.0	1999	WT/Let		0.0	82	
--	Other				WT/Let		0.0		
8541 40 91 ---	Solar cells whether or not assembled in modules or made up into panels	3.2	0.0	1999	WT/Let		0.0	82	
8541 40 93 ---	Photodiodes, phototransistors, photothyristors or photocouples	1.8	0.0	1999	WT/Let		0.0	82	
8541 40 99 ---	Other	1.8	0.0	1999	WT/Let		0.0	82	
8541 50 -	Other semiconductor devices				WT/Let		0.0		
8541 50 10 --	Wafers not yet cut into chips	7	0.0	1999	WT/Let		0.0	83	
8541 50 90 --	Other	7	0.0	1999	WT/Let		0.0	83	
8541 60 00 -	Mounted piezo-electric crystals	5.6	0.0	1999	WT/Let		0.0	84	
8541 90 00 -	Parts	4.1	0.0	1999	WT/Let		0.0	85	
8542	Electronic integrated circuits and microassemblies :				WT/Let		0.0		
-	Monolithic digital integrated circuits				WT/Let		0.0		
8542 12 00 --	Cards incorporating an electronic integrated circuit («smart» cards)	14	0.0	1999	WT/Let		0.0	86	
8542 13 --	Metal oxide semiconductors (MOS technology)				WT/Let		0.0		
8542 13 01 ---	Wafers not yet cut into chips	7	0.0	1999	WT/Let		0.0	87	
8542 13 05 ---	Chips	7	0.0	1999	WT/Let		0.0	87	
----	Other				WT/Let		0.0		
-----	Memories				WT/Let		0.0		
-----	Dynamic random-access memories (D-RAMs)				WT/Let		0.0		

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>	Attach.-
					<u>concession</u>	<u>incorporated in a</u>	<u>A-A-Sect.</u>	
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8542 13 11	----- With a storage capacity not exceeding 4 Mbits	7	0.0	1999	WT/Let		0.0	87
8542 13 13	----- With a storage capacity exceeding 4 Mbits but not exceeding 16 Mbits	7	0.0	1999	WT/Let		0.0	87
8542 13 15	----- With a storage capacity exceeding 16 Mbits but not exceeding 64 Mbits	7	0.0	1999	WT/Let		0.0	87
8542 13 17	----- With a storage capacity exceeding 64 Mbits	7	0.0	1999	WT/Let		0.0	87
	----- Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs)				WT/Let		0.0	
8542 13 22	----- With a storage capacity not exceeding 256 Kbits	0.0	0.0	1997	WT/Let		0.0	87
8542 13 25	----- With a storage capacity exceeding 256 Kbits but not exceeding 1 Mbit	0.0	0.0	1997	WT/Let		0.0	87
8542 13 27	----- With a storage capacity exceeding 1 Mbit	0.0	0.0	1997	WT/Let		0.0	87
	----- UV erasable, programmable, read only memories (EPROMs)				WT/Let		0.0	
8542 13 32	----- With a storage capacity not exceeding 1 Mbit	0.0	0.0	1997	WT/Let		0.0	87
8542 13 35	----- With a storage capacity exceeding 1 Mbit but not exceeding 4 Mbits	0.0	0.0	1997	WT/Let		0.0	87
8542 13 37	----- With a storage capacity exceeding 4 Mbits	0.0	0.0	1997	WT/Let		0.0	87
	----- Electrically erasable, programmable, read only memories (E ² PROMs), including FLASH E ² PROMs				WT/Let		0.0	
	----- FLASH E ² PROMs				WT/Let		0.0	
8542 13 41	----- With a storage capacity not exceeding 1 Mbit	0.0	0.0	1997	WT/Let		0.0	87
8542 13 43	----- With a storage capacity exceeding 1 Mbit but not exceeding 4 Mbits	0.0	0.0	1997	WT/Let		0.0	87
8542 13 45	----- With a storage capacity exceeding 4 Mbits but not exceeding 16 Mbits	0.0	0.0	1997	WT/Let		0.0	87
8542 13 47	----- With a storage capacity exceeding 16 Mbits	0.0	0.0	1997	WT/Let		0.0	87
8542 13 49	----- Other	0.0	0.0	1997	WT/Let		0.0	87

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	Earlier INRs	<u>Attach.</u>
					<u>concession</u>	<u>incorporated in a</u>		<u>Attach. A-A-Sect.</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>ODCs</u>	<u>Attach.-</u>
								<u>Sect. 1</u>
								<u>2</u>
								<u>B</u>
8542 13 51	----- Read only memories, non-programmable (ROMs); content addressable memories (CAMs); first-in/first-out read/write memories (FIFOs); last-in/first-out read/write memories (LIFOs); ferroelectric memories	0.0	0.0	1997	WT/Let		0.0	87
8542 13 53	----- Other memories	7	0.0	1999	WT/Let		0.0	87
8542 13 55	----- Microprocessors	0.0	0.0	1997	WT/Let		0.0	87
	----- Microcontrollers and microcomputers				WT/Let		0.0	
8542 13 61	----- With a processing capacity not exceeding 4 bits	5.6	0.0	1999	WT/Let		0.0	87
8542 13 63	----- With a processing capacity exceeding 4 bits but not exceeding 8 bits	7	0.0	1999	WT/Let		0.0	87
8542 13 65	----- With a processing capacity exceeding 8 bits but not exceeding 16 bits	7	0.0	1999	WT/Let		0.0	87
8542 13 67	----- With a processing capacity exceeding 16 bits but not exceeding 32 bits	7	0.0	1999	WT/Let		0.0	87
8542 13 69	----- With a processing capacity exceeding 32 bits	7	0.0	1999	WT/Let		0.0	87
	----- Other				WT/Let		0.0	
8542 13 70	----- Microperipherals	5.6	0.0	1999	WT/Let		0.0	87
	----- Other				WT/Let		0.0	
8542 13 72	----- Full custom logic circuits	7	0.0	1999	WT/Let		0.0	87
8542 13 74	----- Gate arrays	7	0.0	1999	WT/Let		0.0	87
8542 13 76	----- Standard cells	7	0.0	1999	WT/Let		0.0	87
8542 13 82	----- Programmable logic circuits	5.6	0.0	1999	WT/Let		0.0	87
8542 13 84	----- Standard logic circuits	5.6	0.0	1999	WT/Let		0.0	87
	----- Other				WT/Let		0.0	
8542 13 91	----- Control circuits; interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let		0.0	87
8542 13 99	----- Other	7	0.0	1999	WT/Let		0.0	87
8542 14	-- Circuits obtained by bipolar technology				WT/Let		0.0	
8542 14 01	--- Wafers not yet cut into chips	7	0.0	1999	WT/Let		0.0	88
8542 14 05	--- Chips	7	0.0	1999	WT/Let		0.0	88
	--- Other				WT/Let		0.0	
	---- Memories				WT/Let		0.0	
8542 14 10	----- Dynamic random-access memories (D-RAMs)	7	0.0	1999	WT/Let		0.0	88

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Attach.					
					concession	incorporated in a	Attach. A-A-Sect.	Attach.-				
					established	INR	GATT Schedule	Earlier INRs	ODCs	Sect. 1	2	B
8542 14 15	----- Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs); read only memories, non-programmable (ROMs); content addressable memories (CAMs); first-in/first-out read/write memories (FIFOs); last-in/first-out read/write memories (LIFOs); ferroelectric memories	0.0	0.0	1997	WT/Let				0.0	88		
8542 14 20	----- Electrically erasable, programmable, read only memories (E ² PROMs), including FLASH E ² PROMs	0.0	0.0	1997	WT/Let				0.0	88		
8542 14 22	----- UV erasable, programmable, read only memories (EPROMs)	0.0	0.0	1997	WT/Let				0.0	88		
8542 14 29	----- Other memories	7	0.0	1999	WT/Let				0.0	88		
8542 14 30	---- Microprocessors	0.0	0.0	1997	WT/Let				0.0	88		
	---- Microcontrollers and microcomputers				WT/Let				0.0			
8542 14 42	----- With a processing capacity not exceeding 4 bits	5.6	0.0	1999	WT/Let				0.0	88		
8542 14 44	----- With a processing capacity exceeding 4 bits	7	0.0	1999	WT/Let				0.0	88		
	---- Other				WT/Let				0.0			
8542 14 50	----- Microperipherals	5.6	0.0	1999	WT/Let				0.0	88		
	----- Other				WT/Let				0.0			
8542 14 60	----- Full custom logic circuits	7	0.0	1999	WT/Let				0.0	88		
8542 14 65	----- Gate arrays	7	0.0	1999	WT/Let				0.0	88		
8542 14 70	----- Standard cells	7	0.0	1999	WT/Let				0.0	88		
8542 14 75	----- Programmable logic circuits	5.6	0.0	1999	WT/Let				0.0	88		
8542 14 80	----- Standard logic circuits	5.6	0.0	1999	WT/Let				0.0	88		
	----- Other				WT/Let				0.0			
8542 14 91	----- Control circuits; interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let				0.0	88		
8542 14 99	----- Other	7	0.0	1999	WT/Let				0.0	88		
8542 19	-- Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)				WT/Let				0.0			
8542 19 01	--- Wafers not yet cut into chips	7	0.0	1999	WT/Let				0.0	89		
8542 19 05	--- Chips	7	0.0	1999	WT/Let				0.0	89		
	--- Other				WT/Let				0.0			
	---- Memories				WT/Let				0.0			
8542 19 15	----- Dynamic random-access memories (D-RAMs)	7	0.0	1999	WT/Let				0.0	89		

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach.</u>		
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>Attach. A-Sect.</u>	<u>Attach.-</u>
					<u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
								<u>Sect. 1</u>	<u>2</u>
								<u>B</u>	
	----- Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs)				WT/Let			0.0	
8542 19 22	----- With a storage capacity not exceeding 256 Kbits	0.0	0.0	1997	WT/Let			0.0	89
8542 19 25	----- With a storage capacity exceeding 256 Kbits but not exceeding 1 Mbit	0.0	0.0	1997	WT/Let			0.0	89
8542 19 27	----- With a storage capacity exceeding 1 Mbit	0.0	0.0	1997	WT/Let			0.0	89
8542 19 31	----- UV erasable, programmable, read only memories (EPROMs)	0.0	0.0	1997	WT/Let			0.0	89
8542 19 35	----- Electrically erasable, programmable, read only memories (E ² PROMs), including FLASH E ² PROMs	0.0	0.0	1997	WT/Let			0.0	89
8542 19 41	----- Read only memories, non-programmable (ROMs); content addressable memories (CAMs); first-in/first-out read/write memories (FIFOs); last-in/first-out read/write memories (LIFOs); ferroelectric memories	0.0	0.0	1997	WT/Let			0.0	89
8542 19 49	----- Other memories	7	0.0	1999	WT/Let			0.0	89
8542 19 55	----- Microprocessors	0.0	0.0	1997	WT/Let			0.0	89
	----- Microcontrollers and microcomputers				WT/Let			0.0	
8542 19 62	----- With a processing capacity not exceeding 4 bits	5.6	0.0	1999	WT/Let			0.0	89
8542 19 68	----- With a processing capacity exceeding 4 bits	7	0.0	1999	WT/Let			0.0	89
	----- Other				WT/Let			0.0	
8542 19 71	----- Microperipherals	5.6	0.0	1999	WT/Let			0.0	89
	----- Other				WT/Let			0.0	
8542 19 72	----- Full custom logic circuits	7	0.0	1999	WT/Let			0.0	89
8542 19 74	----- Gate arrays	7	0.0	1999	WT/Let			0.0	89
8542 19 76	----- Standard cells	7	0.0	1999	WT/Let			0.0	89
8542 19 82	----- Programmable logic circuits	5.6	0.0	1999	WT/Let			0.0	89
8542 19 84	----- Standard logic circuits	5.6	0.0	1999	WT/Let			0.0	89
	----- Other				WT/Let			0.0	
8542 19 92	----- Control circuits; interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let			0.0	89
8542 19 98	----- Other	7	0.0	1999	WT/Let			0.0	89
8542 30	- Other monolithic integrated circuits				WT/Let			0.0	
8542 30 10	-- Wafers not yet cut into chips	7	0.0	1999	WT/Let			0.0	90
8542 30 20	-- Chips	7	0.0	1999	WT/Let			0.0	90

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Earlier INRs	Attach.		
					concession established	incorporated in a		Attach. A	Attach. A-Sect.	Attach.-
					INR	GATT Schedule	ODCs	Sect. 1	2	B
	-- Other				WT/Let		0.0			
8542 30 30	--- Amplifiers	7	0.0	1999	WT/Let		0.0	90		
8542 30 50	--- Voltage and current regulators	7	0.0	1999	WT/Let		0.0	90		
	--- Control circuits				WT/Let		0.0			
8542 30 61	---- Smartpower circuits	7	0.0	1999	WT/Let		0.0	90		
	---- Other				WT/Let		0.0			
8542 30 65	----- Mixed analogue-digital circuits	7	0.0	1999	WT/Let		0.0	90		
8542 30 69	----- Other	7	0.0	1999	WT/Let		0.0	90		
8542 30 70	--- Interface circuits; interface circuits capable of performing control functions	7	0.0	1999	WT/Let		0.0	90		
	--- Other				WT/Let		0.0			
8542 30 91	---- Smartpower circuits	7	0.0	1999	WT/Let		0.0	90		
	---- Other				WT/Let		0.0			
8542 30 95	----- Mixed analogue-digital circuits	7	0.0	1999	WT/Let		0.0	90		
8542 30 99	----- Other				WT/Let		0.0			
8542 40	- Hybrid integrated circuits				WT/Let		0.0			
8542 40 10	-- Microprocessors, microcontrollers and microcomputers	7	0.0	1999	WT/Let		0.0	91		
8542 40 30	-- Converters	7	0.0	1999	WT/Let		0.0	91		
8542 40 50	-- Amplifiers	7	0.0	1999	WT/Let		0.0	91		
8542 40 90	-- Other	7	0.0	1999	WT/Let		0.0	91		
8542 50 00	- Electronic microassemblies	7	0.0	1999	WT/Let		0.0	92		
8542 90 00	- Parts	4.1	0.0	1999	WT/Let		0.0	93		
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter				WT/Let		0.0			
	- Particle accelerators				WT/Let		0.0			
8543 11 00	-- Ion implanters for doping semiconductor materials	0.0	0.0	1997	WT/Let		0.0		167	
8543 30	- Machines and apparatus for electroplating, electrolysis or electrophoresis				WT/Let		0.0			
8543 30 10	-- Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers	0.0	0.0	1997	WT/Let		0.0		168	
8543 30 20	-- Apparatus for wet etching, developing, stripping or cleaning liquid crystal display substrates	0.0	0.0	1997	WT/Let		0.0		168	
8543 30 90	-- Other				WT/Let		0.0			
	- Other machines and apparatus				WT/Let		0.0			
8543 81 00	-- Proximity cards and tags	5	0.0	2000	WT/Let		0.0	94		
8543 89	-- Other				WT/Let		0.0			
8543 89 10	--- Flight recorders, for use in civil aircraft				WT/Let		0.0			

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Sec. 1</u>	<u>Sec. 2</u>	<u>Sec. 3</u>	<u>Sec. 4</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>		
8543 89 15 ---	Electrical machines with translation or dictionary functions	5	0.0	2000	WT/Let			0.0	95	
8543 89 17 ---	Apparatus combined with an automatic data processing machine, freely programmable by the user	5	0.0	2000	WT/Let			0.0		191,
8543 89 20 ---	Aerial amplifiers				WT/Let			0.0		
	--- Sunbeds, sunlamps and similar suntanning equipment				WT/Let			0.0		
	---- For fluorescent tubes using ultraviolet A rays				WT/Let			0.0		
8543 89 51 -----	With a maximum tube length of 100 cm				WT/Let			0.0		
8543 89 55 -----	Other				WT/Let			0.0		
8543 89 59 ----	Other				WT/Let			0.0		
	--- Apparatus for physical deposition on semiconductors wafers.				WT/Let			0.0		
8543 89 70 ----	by sputtering on semiconductor wafers	0.0	0.0	1997	WT/Let			0.0		141
8543 89 72 ----	Other	5	0.0	2000	WT/Let			0.0		147
8543 89 73 ---	Encapsulation equipment for assembly of semiconductors	5	0.0	2000	WT/Let			0.0		144
8543 89 79 ---	Multimedia upgrade kits, for automatic data processing machines and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones, and a printed circuit assembly that enables the automatic data processing and units thereof to process audio signals (sound cards)	5	0.0	2000	WT/Let			0.0		202,
8543 89 90 ---	Other				WT/Let			0.0		
8543 90 -	Parts				WT/Let			0.0		
8543 90 10 --	Assemblies and sub-assemblies consisting of two or more parts or pieces fastened or joined together, for flight recorders, for use in civil aircraft				WT/Let			0.0		
8543 90 20 --	Printed circuit assemblies for physical incorporation into an automatic data processing machine	5	0.0	2000	WT/Let			0.0		199,
8543 90 30 --	Of apparatus of subheadings 8543 11 00, 8543 30 10, 8543 30 20, 8543 89 70, 8543 89 72 and 8543 89 73	5	0.0	2000	WT/Let			0.0		170,14 199, 9,153,1 69,155, 158
8543 90 90 --	Other				WT/Let			0.0		

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Attach.					
					concession	incorporated in a	Attach. A	A-Sect.	Attach.-			
					established	INR	GATT Schedule	Earlier INRs	ODCs	Sect. 1	2	B
8544	Insulated (including enamelled or anodised) wire, cable (including coaxial cable) and other insulated electric conductors, whether or not fitted with connectors; optical fibre cables, made up of individually sheathed fibres, whether or not assembled with electric conductors or fitted with connectors :				WT/Let				0.0			
	- Other electric conductors, for a voltage not exceeding 80 V				WT/Let				0.0			
8544 41	-- Fitted with connectors				WT/Let				0.0			
8544 41 10	--- Of a kind used for telecommunications	4.6	0.0	2000	WT/Let				0.0	96		
8544 41 90	--- Other				WT/Let				0.0			
8544 49	-- Other				WT/Let				0.0			
8544 49 20	--- Of a kind used for telecommunications	4.8	0.0	2000	WT/Let				0.0	97		
8544 49 80	--- Other				WT/Let				0.0			
	- Other electric conductors, for a voltage exceeding 80 volts but not exceeding 1 000 volts				WT/Let				0.0			
8544 51	-- Fitted with connectors				WT/Let				0.0			
8544 51 10	--- Of a kind used for telecommunications	4.6	0.0	2000	WT/Let				0.0	98		
8544 51 90	--- Other				WT/Let				0.0			
8544 70 00	- Optical fibre cables	6.3	0.0	2000	WT/Let				0.0	99		
8548	Waste and scrap of primary cells, primary batteries and electric accumulators; spent primary cells, spent primary batteries and spent electric accumulators; electrical parts of machinery or apparatus, not specified or included elsewhere in this chapter				WT/Let				0.0			
8548 10	- Waste and scrap of primary cells, primary batteries and electric accumulators; spent primary cells, spent primary batteries and spent electric accumulators				WT/Let				0.0			
8548 10 10	-- Spent primary cells, spent primary batteries				WT/Let				0.0			
	-- Spent electric accumulators				WT/Let				0.0			
8548 10 21	--- Lead-acid accumulators				WT/Let				0.0			
8548 10 29	--- Other				WT/Let				0.0			
	-- Waste and scrap of primary cells, primary batteries and electric accumulators				WT/Let				0.0			
8548 10 91	--- Containing lead				WT/Let				0.0			
8548 10 99	--- Other				WT/Let				0.0			

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Earlier INRs	Attach.		
					concession established INR	incorporated in a GATT Schedule		A	A-Sect.	Attach.-
							ODCs	Sect. 1	2	B
8548 90 00	- Other				WT/Let		0.0			
8548 90 10	-- Dynamic random-access memories (D-RAMs) in multi-combinational forms such as 'stack D-RAMs' and modules	3.3	0.0	2000	WT/Let		0.0			199,
8548 90 90	-- Other				WT/Let		0.0			
9006	Photographic (other than cinematographic) cameras; photographic flashlight apparatus and flashbulbs other than discharge lamps of heading No 8539 :				WT/Let		0.0			
9006 10	- Cameras of a kind used for preparing printing plates or cylinders				WT/Let		0.0			
9006 10 10	-- Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	0.0	0.0	1997	WT/Let		0.0		181	
9006 10 90	-- Other				WT/Let		0.0			
	- Parts and accessories:				WT/Let		0.0			
9006 91 00	-- For cameras				WT/Let		0.0			
	-- Other				WT/Let		0.0			
9006 99 10	-- of apparatus of subheading 9006 10 10	4	0.0	2000	WT/Let		0.0		182	
9006 99 90	-- Other				WT/Let		0.0			
9009	Photocopying apparatus incorporating an optical system or of the contact type and thermo-copying apparatus:				WT/Let		0.0			
	- Electrostatic photocopying apparatus				WT/Let		0.0			
9009 11 00	-- Operating by reproducing the original image directly onto the copy (direct process)	6.5	0.0	2000	WT/Let		0.0	100		
	- Other photocopying apparatus				WT/Let		0.0			
9009 21 00	-- Incorporating an optical system	6.5	0.0	2000	WT/Let		0.0	101		
9009 90	- Parts and accessories				WT/Let		0.0			
9009 90 10	-- Of electrostatic photocopying apparatus or other photocopying apparatus incorporating an optical system	6.5	0.0	2000	WT/Let		0.0	102		
9009 90 90	-- Other	3.8	0.0	2000	WT/Let		0.0	102		
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection of circuit patterns on sensitized semi-conductor material), not specified or included elsewhere in this chapter, negatoscopes, projection screens				WT/Let		0.0			

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Sect. 1</u>
									<u>2</u>
									<u>B</u>
	- Apparatus for the projection or drawing of circuit patterns on sensitized semiconductor materials:				WT/Let			0.0	
9010 41 00	-- Direct write-on-wafer apparatus	0.0	0.0	1997	WT/Let			0.0	171
9010 42 00	-- Step and repeat aligners	0.0	0.0	1997	WT/Let			0.0	172
9010 49 00	-- Other	0.0	0.0	1997	WT/Let			0.0	173
	-- Other apparatus and equipment for photographic (including cinematographic) laboratories; negatoscopes				WT/Let			0.0	
9010 50 10	--- Apparatus for the projection or drawing of circuit patterns on sensitized flat panel displays substrates	3.6	0.0	2000	WT/Let			0.0	173
9010 50 90	--- Other				WT/Let			0.0	
9010 90	- Parts and accessories				WT/Let			0.0	
9010 90 10	-- Of apparatus of subheading 9010 41 00, 9010 42 00, 9010 49 00 or 9010 50 10	3.6	0.0	2000	WT/Let			0.0	174
9010 90 90	-- Other				WT/Let			0.0	
9011	Compound optical microscopes, including those for photomicrography, cinephotomicrography or microprojection				WT/Let			0.0	
9011 10	- Stereoscopic microscopes				WT/Let			0.0	
9011 10 10	-- fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	8	0.0	2000	WT/Let			0.0	175
9011 10 90	-- Other				WT/Let			0.0	
9011 20	- Other microscopes, for photomicrography, cinephotomicrography or micro-projection				WT/Let			0.0	
9011 20 10	-- fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	8	0.0	2000	WT/Let			0.0	176
9011 20 90	-- Other				WT/Let			0.0	
9011 90	- Parts and accessories				WT/Let			0.0	
9011 90 10	-- Of apparatus of subheadings 9011 10 10 or 9011 20 10	8	0.0	2000	WT/Let			0.0	177,178
9011 90 90	-- Other				WT/Let			0.0	
9012	Microscopes other than optical microscopes, diffractio microscopes				WT/Let			0.0	
9012 10	- Microscopes other than optical microscopes and diffraction apparatus				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>	<u>Sec. 1</u>	<u>Sec. 2</u>	<u>Sec. B</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	
9012 10 10 --	Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	4.5	0.0	2000	WT/Let			0.0	179
9012 10 90 --	Other				WT/Let			0.0	
9012 90 -	Parts and accessories				WT/Let			0.0	
9012 90 10 --	Of apparatus of subheading 9012 10 00	4.5	0.0	2000	WT/Let			0.0	180
9012 90 90 --	Other				WT/Let			0.0	
9013	Liquid crystal devices not consisting articles provided for more specifically in other headings; lasers, other than laser diodes; other optical appliances and instruments, not specified or included elsewhere in this Chapter				WT/Let			0.0	
9013 80 -	Other devices, appliances and instruments				WT/Let			0.0	
	-- Liquid crystal devices:				WT/Let			0.0	
	--- Active matrix liquid crystal devices				WT/Let			0.0	
9013 80 11 ----	Colour	6.5	0.0	2000	WT/Let			0.0	193,
9013 80 19 ----	Black and white or other monochrome	6.5	0.0	2000	WT/Let			0.0	193,
9013 80 30 ---	Other	6.5	0.0	2000	WT/Let			0.0	193,
9013 80 90 --	Other				WT/Let			0.0	
9013 90 -	Parts and accessories				WT/Let			0.0	
	-- Other				WT/Let			0.0	
9013 90 10 ---	For liquid crystal devices (LCD)	6.5	0.0	2000	WT/Let			0.0	193,
9013 90 90 ---	Other				WT/Let			0.0	
9017	Drawing, marking-out or mathematical calculating instruments (for example, drafting machines, pantographs, protractors, drawing sets, slide rules, disc calculators); instruments for measuring length, for use in the hand (for example, measuring rods and tapes, micrometers, callipers), not specified or included elsewhere in this chapter :				WT/Let			0.0	
9017 10 -	Drafting tables and machines, whether or not automatic				WT/Let			0.0	
9017 10 10 --	Plotters	3.7	0.0	2000	WT/Let			0.0	198,
9017 10 90 --	Other				WT/Let			0.0	
9017 20 -	Other drawing, marking-out or mathematical calculating instruments				WT/Let			0.0	
	-- Drawing instruments				WT/Let			0.0	

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Earlier INRs	ODCs	Attach.		
					concession	incorporated in a			Attach. A	A-Sect.	Attach.-
					established	INR	GATT Schedule		Sect. 1	2	B
9017 20 05 ---	Plotters	3.7	0.0	2000	WT/Let			0.0			198,
9017 20 11 ---	Drawing sets				WT/Let			0.0			
9017 20 19 ---	Other				WT/Let			0.0			
	-- Marking-out instruments				WT/Let			0.0			
9017 20 31 ---	Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	0.0	0.0	1997	WT/Let			0.0		181	
9017 20 39 ---	Other				WT/Let			0.0			
9017 20 90 --	Mathematical calculating instruments (including slide rules, disc calculators and the like)				WT/Let			0.0			
9017 90 -	Parts and accessories				WT/Let			0.0			
9017 90 10 --	For apparatus of subheading 9017 20 31	3.7	0.0	2000	WT/Let			0.0		182,183	
9017 90 90 --	Other				WT/Let			0.0			
9026	Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading No 9014, 9015, 9028 or 9032 :				WT/Let			0.0			
9026 10 -	For measuring or checking the flow or level of liquids				WT/Let			0.0			
9026 10 10 --	For use in civil aircraft	0.0	0.0	1997	WT/Let			0.0	103		
	-- Other				WT/Let			0.0			
	--- Electronic				WT/Let			0.0			
9026 10 51 ----	Flow meters	4.8	0.0	2000	WT/Let			0.0	103		
9026 10 59 ----	Other	4.8	0.0	2000	WT/Let			0.0	103		
	--- Other				WT/Let			0.0			
9026 10 91 ----	Flow meters	3.6	0.0	2000	WT/Let			0.0	103		
9026 10 99 ----	Other	3.6	0.0	2000	WT/Let			0.0	103		
9026 20 -	For measuring or checking pressure				WT/Let			0.0			
9026 20 10 --	For use in civil aircraft	0.0	0.0	1997	WT/Let			0.0	104		
	-- Other				WT/Let			0.0			
9026 20 30 ---	Electronic	4.8	0.0	2000	WT/Let			0.0	104		
	--- Other				WT/Let			0.0			
	---- Spiral or metal diaphragm type pressure gauges				WT/Let			0.0			
9026 20 51 -----	Appliances for measuring and non-automatically regulating tyre pressure	3.3	0.0	2000	WT/Let			0.0	104		
9026 20 59 -----	Other	3.3	0.0	2000	WT/Let			0.0	104		
9026 20 90 ----	Other	3.3	0.0	2000	WT/Let			0.0	104		

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	Earlier INRs	<u>Attach. A</u>	<u>Attach. A</u>	<u>Attach. A</u>
					<u>concession</u>	<u>incorporated in a</u>		<u>Sect. 1</u>	<u>2</u>	<u>B</u>
					<u>established</u>	<u>GATT Schedule</u>	<u>ODCs</u>			
9026 80	- Other instruments or apparatus				WT/Let		0.0			
9026 80 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	105		
	-- Other				WT/Let		0.0			
9026 80 91	--- Electronic	4.8	0.0	2000	WT/Let		0.0	105		
9026 80 99	--- Other	3.6	0.0	2000	WT/Let		0.0	105		
9026 90	- Parts and accessories				WT/Let		0.0			
9026 90 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	106		
9026 90 90	-- Other	3.3	0.0	2000	WT/Let		0.0	106		199,
9027	Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes :				WT/Let		0.0			
9027 20	- Chromatographs and electrophoresis instruments				WT/Let		0.0			
9027 20 10	-- Chromatographs	3.5	0.0	2000	WT/Let		0.0	107		
9027 20 90	-- Electrophoresis instruments	4.4	0.0	2000	WT/Let		0.0	107		
9027 30 00	- Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)	3.5	0.0	2000	WT/Let		0.0	108		
9027 50 00	- Other instruments and apparatus using optical radiations (UV, visible, IR)	4.4	0.0	2000	WT/Let		0.0	109		
9027 80	- Other instruments and apparatus				WT/Let		0.0			
	-- Electronic				WT/Let		0.0			
9027 80 11	--- pH meters, rH meters and other apparatus for measuring conductivity	4.4	0.0	2000	WT/Let		0.0	110		
9027 80 15	--- Apparatus for performing measurements of the physical properties of semiconductor materials or associated insulating and conducting layers during the semiconductor wafer production process	0.0	0.0	1997	WT/Let		0.0	110		
9027 80 18	--- Other	4.4	0.0	2000	WT/Let		0.0	110		
	-- Other				WT/Let		0.0			
9027 80 91	--- Viscometers, porosimeters and expansion meters	4	0.0	2000	WT/Let		0.0	110		

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Earlier INRs	Attach.		
					concession established	incorporated in a GATT Schedule		Attach. A	Attach. A-Sect. 1	Attach. A-Sect. 2
9027 80 95	--- Apparatus for performing measurements of the physical properties of semiconductor materials or associated insulating and conducting layers during the semiconductor wafer production process	0.0	0.0	1997	WT/Let		0.0	110		
9027 80 98	--- Other	4	0.0	2000	WT/Let		0.0	110		
9027 90	- Microtomes; parts and accessories				WT/Let		0.0			
9027 90 10	-- Microtomes				WT/Let		0.0			
9027 90 50	-- Part and accessories of apparatus of subheading 9027 20 to 9027 80	4.4	0.0	2000	WT/Let		0.0	111		199,
9027 90 80	-- Parts and accessories of microtomes or of gas or smoke analysis apparatus				WT/Let		0.0			
9030	Oscilloscopes, spectrum analysers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading No 9028; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionizing radiations :				WT/Let		0.0			
9030 40	- Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)				WT/Let		0.0			
9030 40 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let		0.0	112		
9030 40 90	-- Other	5.5	0.0	2000	WT/Let		0.0	112		
	- Other instruments and apparatus				WT/Let		0.0			
9030 82 00	-- For measuring or checking semiconductor wafers or devices	0.0	0.0	1997	WT/Let		0.0		184	
9030 90	- Parts and accessories				WT/Let		0.0			
9030 90 10	-- For use in civil aircraft				WT/Let		0.0			
9030 90 20	-- For apparatus of subheading 9030 82 00	4.4	0.0	2000	WT/Let		0.0		185,18 6	199,
9030 90 80	-- Other				WT/Let		0.0			
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this chapter; profile projectors :				WT/Let		0.0			
	- Other optical instruments and appliances				WT/Let		0.0			

HS96	Description	Base rate	Bound rate	Implementation	<u>Present</u>	<u>Concession first</u>	Earlier INRs	<u>Attach.</u>	ODCs	<u>Attach.</u>	<u>Attach.</u>
					<u>concession</u>	<u>incorporated in a</u>		<u>A-A-Sect.</u>		<u>A-Sect.</u>	<u>Attach.-</u>
					<u>established</u>	<u>GATT Schedule</u>		<u>Sect. 1</u>		<u>2</u>	<u>B</u>
9031 41 00 --	For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	0.0	0.0	1997	WT/Let				0.0		187
9031 49 --	Other				WT/Let				0.0		
9031 49 10 ---	For measuring surface particulate contamination on semiconductor wafers	0.0	0.0	1997	WT/Let				0.0		188
9031 49 90 ---	Other				WT/Let				0.0		
9031 90 -	Parts and accessories				WT/Let				0.0		
9031 90 10 --	Of instruments, appliances and machines of subheading 9031 80, for use in civil aircraft				WT/Let				0.0		
9031 90 20 --	For apparatus of subheadings 9031 41 00 and 9031 49 10	4.6	0.0	2000	WT/Let				0.0		189,190
9031 90 90 --	Other				WT/Let				0.0		